This is a survey course on the fundamentals of integrated circuit (IC) and semiconductor device fabrication technology. Specialized microelectromechanical systems (MEMS) processing will also be studied. Students will develop an advanced understanding of all aspects of IC fabrication including: materials (Si, SiO2, GaAs, Al, Au, etc.), processes (deposition, etching, lithography, oxidation/diffusion, etc.), and equipment (reactive ion etching, evaporator, plasma sputtering, chemical vapor deposition, etc.). This course will include lab demonstrations conducted in a Class 1000 cleanroom located in the lower level of Engineering Hall.